

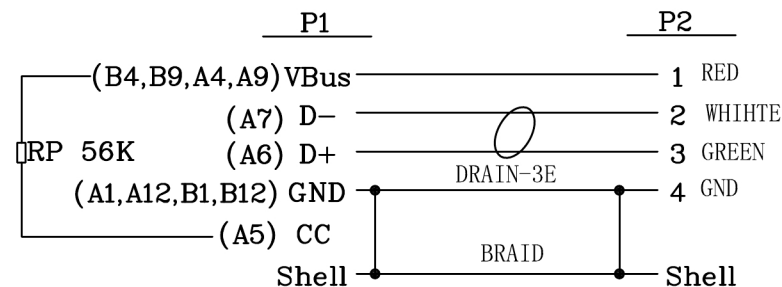
1. test conditions:

1. 100% of short circuit, open circuit test & dislocation.
2. Insulation impedance: 10M ohm (MIN) DC 300V.
3. Conduction impedance: 2 ohm (MAX).
4. Withstand voltage test: DC 300V/10ms

2, processing instructions:

1. C Type end was peeled 10 ~ 15 mm, outside order, in accordance with the thread gauge to conductor LiRu fixture groove (ground to twist In the GND PIN) weaving take 2 ~ 3 shares of twist in the Shell welding Pad, pay attention to the tin point should not be too large.
2. USB AM end and ground wire woven take 2 ~ 3 shares of twisting the welding on the GND Pad (lap plus tin soldering iron shell), pay attention to Tin not too big.
3. The P1 end after good conductor welding the PCB must be UV glue, UV glue dozen thin as far as possible,

4、Pin Assignment:



⑨	A0040411-00002	Low pressure molding compound, transparent color, hardness, 40 ~ 48 d	1	g
⑧	A0020100-00174	USB TYPE C On the tin plating nickel to clamp (one)	1	pcs
⑦	A0020100-00175	USB TYPE C The tin plating nickel to clamp (one)	1	pcs
⑥	A10-R075552	Heat shrinkable casing ~ φ 1.0mm ~ black	0.016	M
⑤	A5-R047107	45P WHITE PVC ROHS	16	g
④	A5-R047011	transparent PE ROHS LDPE	3	g
③	B010-00870	TYPE C-Type Connector With empty PCB+SMT	1	pcs
②	A2-R029107	USB AM L=18.10MM WHITE INSULATION SHELL PLATED: NICKEL	1	pcs
①	A0010306-01042	NO-UL~22AWG(41/0.1TC+250DNylon)*1C+30AWG(19/0.06TC)*2C+3E(26/0.1TC)+AB(16/9/0.06TC 85%TC)OD:3.5MM~ WHITE PVC~NO MARKING	2.0	M
NO		DESCRIPTION	Q'TY	UNIT

REV	ECN	DESCRIPTION	DATE	NAME
TOLERANCE INCHES M/M				
.X	.015	.30		
.XX	.010	.10		
.XXX	.005	.05		
DRAWN BY		zhouwenlong	TITLE: USB 2.0 AM TO CM L=2.0M	
CHECK BY			CUSTOMER :	CPC
APPD BY			CUSTOMER P/N :	PSG91487
SCALE	NONE	DRAWING NO.:	REV.	
UNIT	mm	C06026-00270	A01	
DATE	2017.05.03		1/2	